



ORIENT

Photo coupler

Product Data Sheet

Part Number: OR-352

Customer: _____

Date: _____

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1. Features

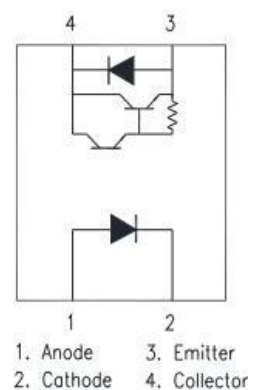
- (1) Current transfer ratio(CTR : MIN. 1000% at $I_F = 1\text{mA}$, $V_{CE} = 2\text{V}$)
- (2) High input -output isolation voltage ($V_{ISO}=3,750\text{Vrms}$)
- (3) High collector-emitter voltage ($V_{CEO} = 300\text{V}$)
- (4) SOP-4 package
- (5) Operating temperature: $-55\text{ }^\circ\text{C}$ to $110\text{ }^\circ\text{C}$
- (6) Safety approval
 - UL approved(No.E323844)
 - VDE approved(No.40029733)
 - CQC approved (No.CQC19001231256)
- (7) In compliance with RoHS, REACH standards
- (8) MSL Level 1



2. Instructions

- The OR-352 series device consists of an infrared led, phototransistor detector. They are encapsulated in a 4 pin SOP encapsulation.
- Pin pitch of OR-352 is 2.54mm

Pin No. and Internal connection diagram



3. Application Range

- (1) Hybrid substrates that require high density mounting.
- (2) Programmable controllers
- (3) System appliance, measuring instruments

4. Max Absolute rated Value (Normal Temperature=25°C)

Parameter		Symbol	Rated Value	Unit
Input	Forward Current	I_F	50	mA
	Junction Temperature	T_J	125	°C
	Reverse Voltage	V_R	6	V
	Consume Power	P	70	mW
Output	Collector and emitter Voltage	V_{CEO}	300	V
	Emitter and collector Voltage	V_{ECO}	0.1	
	Collector Current	I_C	150	mA
	Consume Power	P_C	150	mW
Total Consume Power		P_{tot}	170	mW
*1 Insulation Voltage		V_{iso}	3750	Vrms
Working Temperature		T_{opr}	-55 to + 110	°C
Deposit Temperature		T_{stg}	-55 to + 125	
*2 Soldering Temperature		T_{sol}	260	

*1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

*2. soldering time is 10 seconds.

5. Opto-electronic Characteristics

Parameter		Symbol	Min	Typ.*	Max	Unit	Condition
Input	Forward Voltage	V_F	---	1.2	1.4	V	$I_F=10\text{mA}$
	Reverse Current	I_R	---	---	10	μA	$V_R=4\text{V}$
	Collector capacitance	C_t	---	30	250	pF	$V=0, f=1\text{KHz}$
Output	Collector to emitter Current	I_{CEO}	---	---	200	nA	$V_{CE}=200\text{V},$ $I_F=0\text{mA}$
	Collector and Emitter attenuation Voltage	BV_{CEO}	300	---	---	V	$I_C=0.1\text{mA},$ $I_F=0\text{mA}$
	Emitter and Collector attenuation Voltage	BV_{ECO}	0.1	---	---	V	$I_E=0.01\text{mA},$ $I_F=0\text{mA}$
Transforming Characteristics	*1.Current conversion ratio	CTR	1000	---	15000	%	$I_F=1\text{mA},$ $V_{CE}=2\text{V}$
	Collector Current	I_C	10	---	150	mA	
	Collector and Emitter Saturation Voltage	$V_{CE(sat)}$	---	---	1.2	V	$I_F=20\text{mA},$ $I_C=100\text{mA}$
	Insulation Impedance	R_{iso}	5×10^{10}	1×10^{11}	---	Ω	DC500V, 40~60%R.H.
	Floating Capacitance	C_f	---	0.6	1	pF	$V=0, f=1\text{MHz}$
	Response Time	t_r	---	40	---	μs	$V_{CC}=10\text{V},$
	Descend Time	t_f	---	15	---	μs	$I_C=10\text{mA},$ $R_L=100\Omega$

- Current Conversion Ratio = $I_C / I_F \times 100\%$

6. Order Information

Part Number

OR-352-X-Y-Z

Note

X = Tape and reel option (TP or TP1).

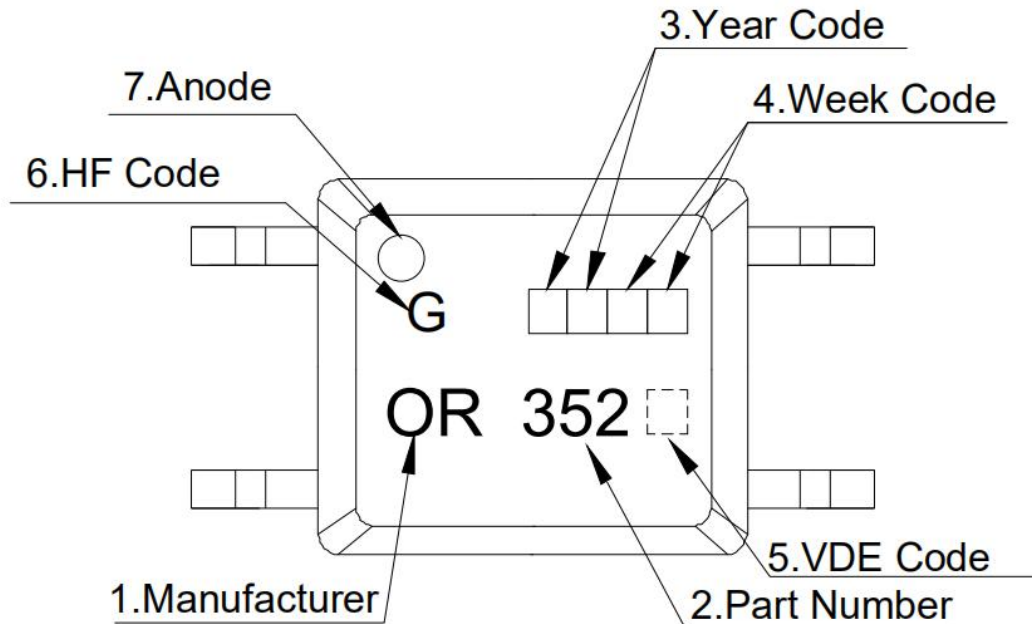
Y = 'V' code for VDE safety (This options is not necessary).

Z = 'G' code for Halogen free.

* VDE Code can be selected.

Option	Description	Packing quantity
None	Standard SMD Option	100 units per tube
TP	Surface mount lead form (low profile) + TP tape & reel option	3000 units per reel
TP1	Surface mount lead form (low profile) + TP1 tape & reel option	3000 units per reel

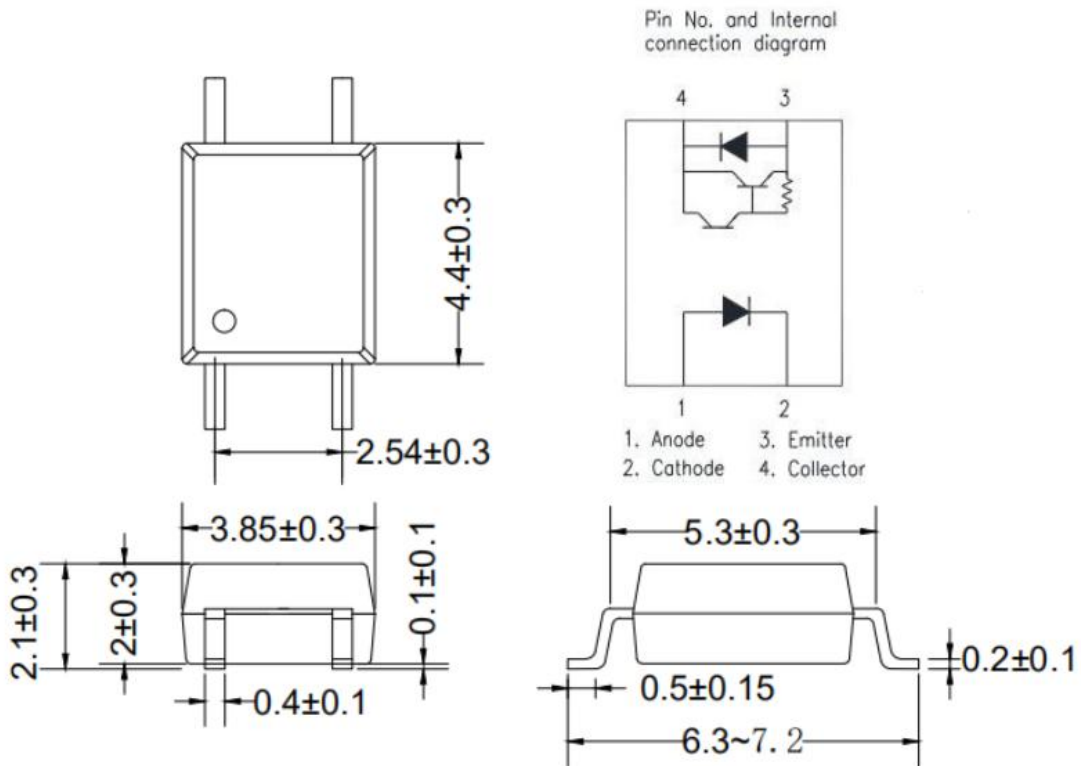
7. Naming Rule



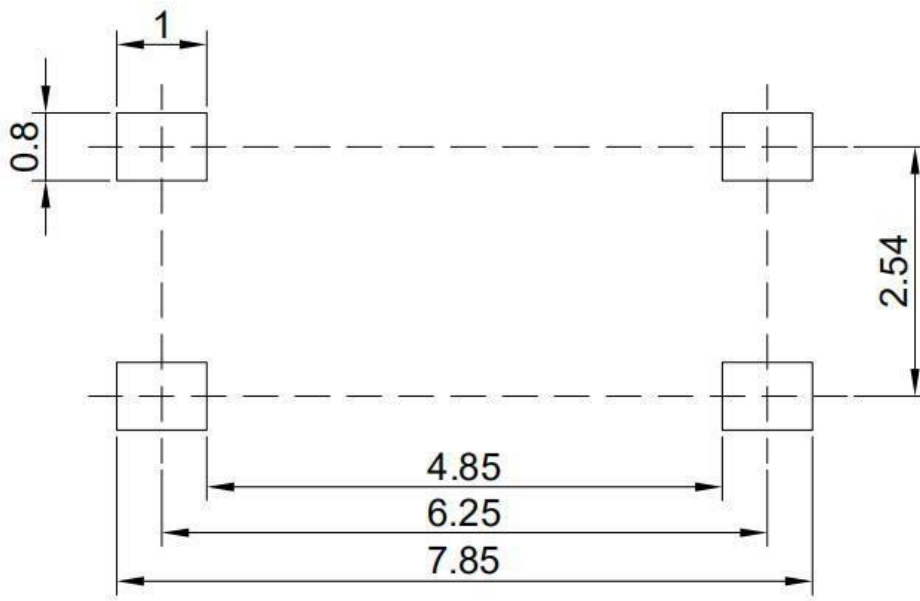
1. Manufacturer : ORIENT.
2. Part Number : 352.
3. Year Code : '21' means '2021' and so on.
4. Week Code : 01 means the first week, 02 means the second week and so on.
5. VDE Code . (Optional)
6. HF Code 'G': Halogen Free.
7. Anode.

* VDE Code can be selected.

8. Outer Dimension



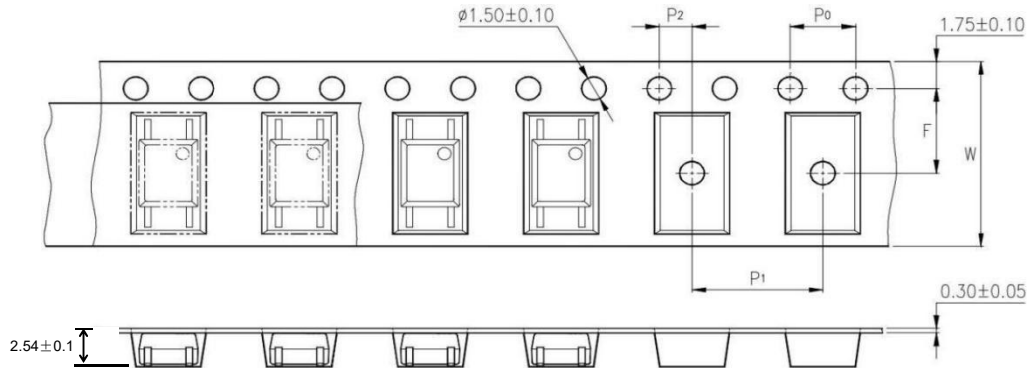
9. Recommended Foot Print Patterns (Mount Pad)



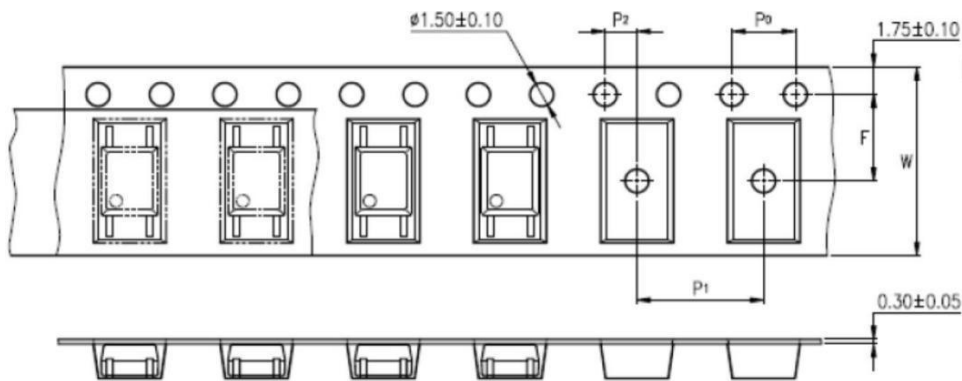
unit: mm

10. Taping Dimensions

(1) OR-352-TP



(2) OR-352-TP1



Description	Symbol	Dimension in mm(inch)
Tape wide	W	12±0.3 (0.472)
Pitch of sprocket holes	P0	4±0.1 (0.157)
Distance of compartment	F	5.5±0.1 (0.217)
	P2	2±0.1 (0.079)
Distance of compartment to compartment	P1	8±0.1 (0.315)

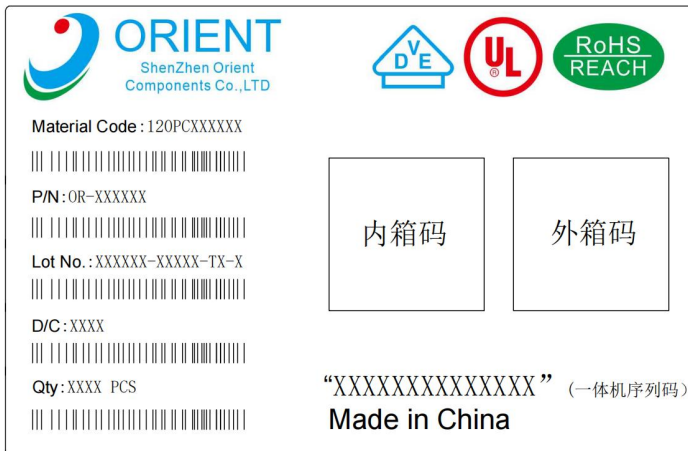
Package Type	TP/TP1
Quantities(pcs)	3000

11. Package Dimension

(1) package dimension

Packing Information	
Packing type	Reel type
Tape Width	12mm
Qty per Reel	3,000pcs
Small box (inner) Dimension	345*345*45mm
Large box (Outer) Dimension	480x360x360mm
Max qty per small box	6,000pcs
Max qty per large box	60,000pcs

(2)Packing Label Sample



Note:

1. Material Code :Product ID.
2. P/N :Contents with "Order Information" in the specification.
3. Lot No. :Product data.
4. D/C :Product weeks.
5. Quantity :Packaging quantity.

12. Reliability Test

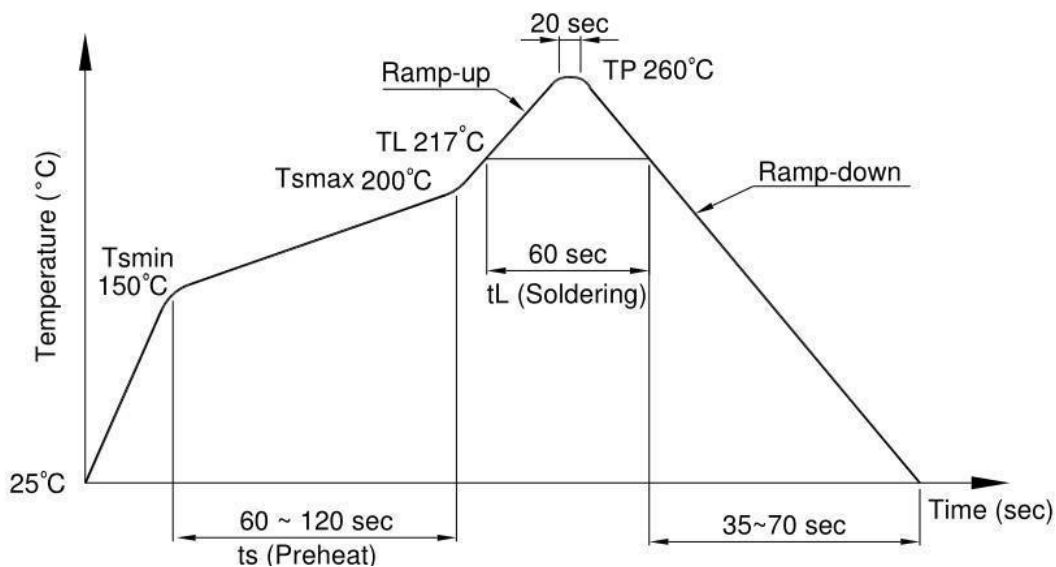
NO.	Reliability Testing					
	ITEMS	QTY (Pcs)	Condition	Process	Device	Standard
1	RSH 耐焊接热	22	260±5℃	5s/3 次	锡炉	JESD22-A106
2	HTSL 高温存储	77	125℃	168 hrs	高温烤箱 测试仪	JESD22-A103
				500 hrs		
				1000 hrs		
3	LTSL 低温存储	77	-55℃	168 hrs	低温箱 测试仪	JESD22-A119
				500 hrs		
				1000 hrs		
4	TC 温度循环	77	H:125℃ 15min ∫ 5min L:-55℃ 15min	300 cycle	冷热冲 击机	JESD22-A104
5	TS 温度冲击	77	H:100℃ 5min ∫ 15s L:-40℃ 5min	300 cycle	冷热冲 击机	JESD22-A106
6	HTOL 高温操作	77	110℃ IF=10mA Vce=5V	168 hrs	高温烤 箱 测试 仪、老 化电 路 板	JESD22-A108
				500 hrs		
				1000 hrs		
7	ESD-HBM 人体模式	22	≥8KV 1Cycle	1次	ESD静电 测试仪	JESD22-A114
8	SD 可焊性	22	Pb-free 245±5℃	5S/1次	锡炉	JESD22-B102
9	HTRB 高温反向偏压	77	@100℃ Vce=280v	168 hrs	高温烤 箱 ， 测 试 仪	JESD22-A103
				500 hrs		
				1000 hrs		
10	H3TRB 温湿度反向偏 压，寿命试验	77	85℃,85%RH Vce=80v	168 hrs	恒温恒湿 机，测 试 仪	JESD22-A101
				500 hrs		
				1000 hrs		
11	Autoclave 压力锅	77	Ta=121 ℃,100%RH,2atm	96hrs	压力锅	JESD22-A102

13. Temperature Profile Of Soldering

(1) IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

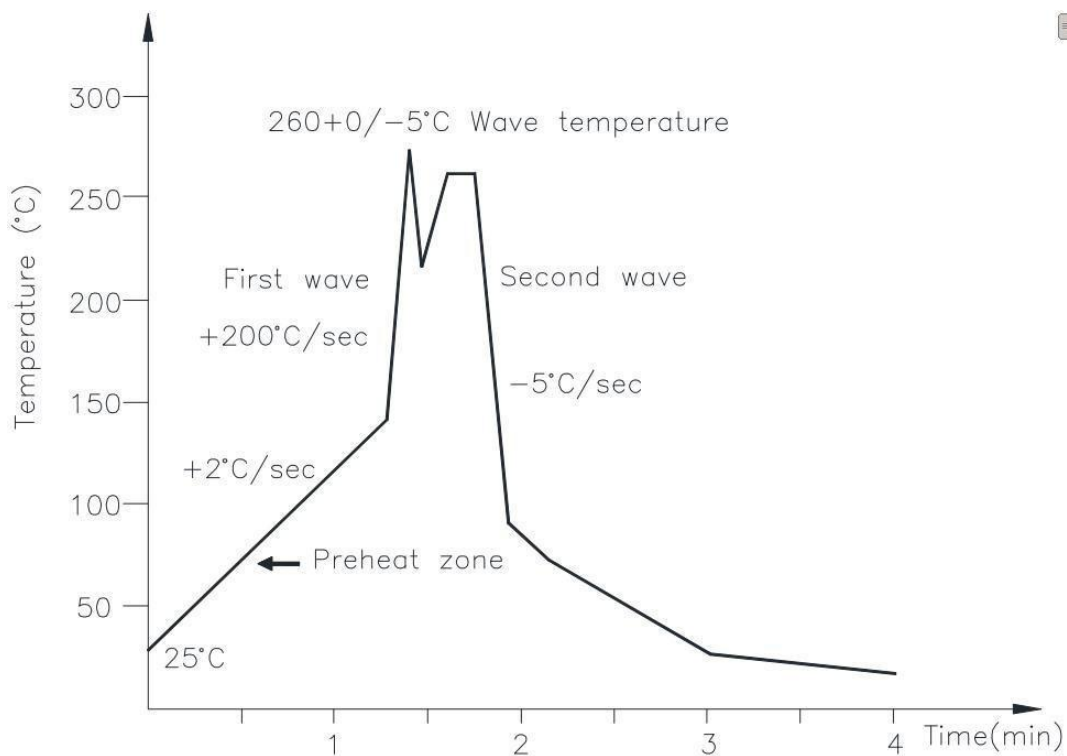
Profile item	Conditions
Preheat	
- Temperature Min (T Smin)	150°C
- Temperature Max (T Smax)	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature (TL)	217°C
- Time (t L)	60 sec
Peak Temperature	260°C
Peak Temperature time	20 sec
Ramp-up rate	3°C / sec max.
Ramp-down rate from peak temperature	3~6°C / sec
Reflow times	≤3



(2) Wave soldering (JEDEC22A111 compliant)

One time soldering is recommended within the condition of temperature.

Temperature	260+0/-5°C
Time	10 sec
Preheat temperature	5 to 140°C
Preheat time	30 to 80 sec



(3) Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature	380+0/-5°C
Time	3 sec max

14. Characteristics Curve

Fig.1 Forward Current vs. Ambient Temperature

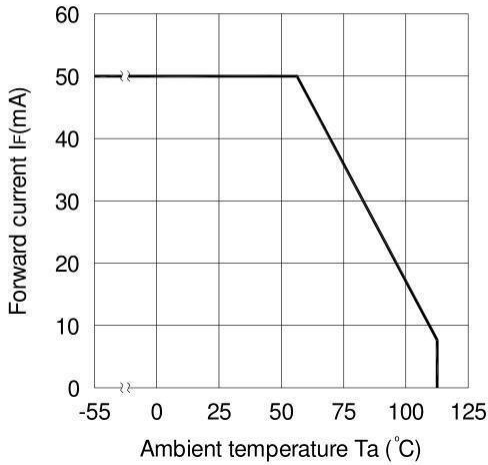


Fig.2 Collector Power Dissipation vs. Ambient Temperature

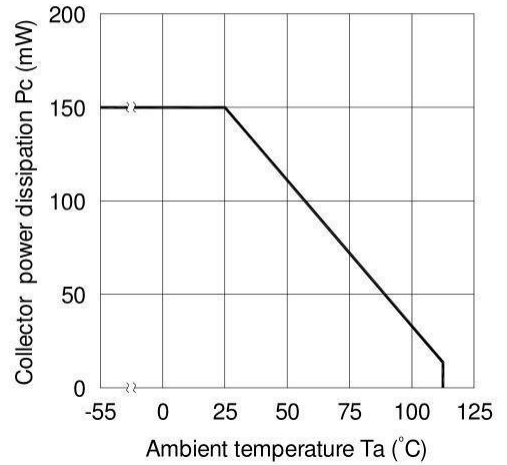


Fig.3 Collector-emitter saturation Voltage vs. Forward current

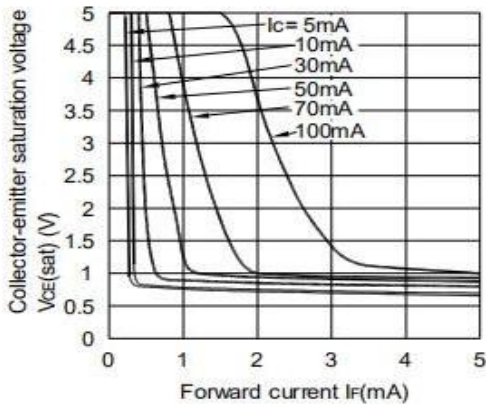


Fig.4 Forward Current vs. Forward Voltage

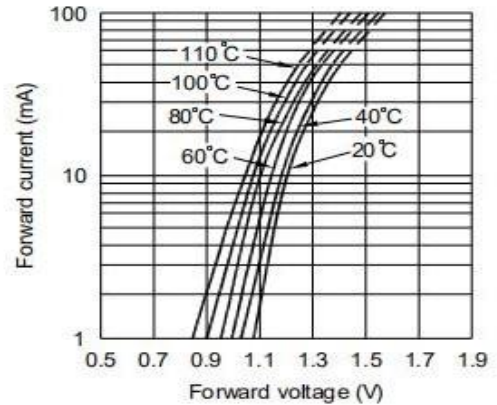


Fig.5 Current Transfer Ratio vs. Forward Current

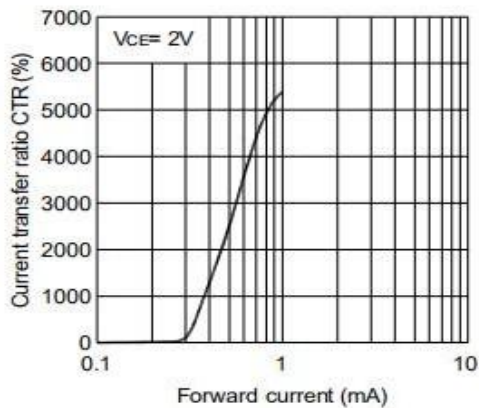


Fig.6 Collector Current vs. Collector-emitter Voltage

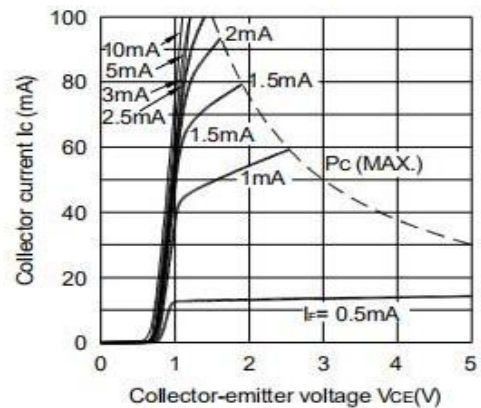


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

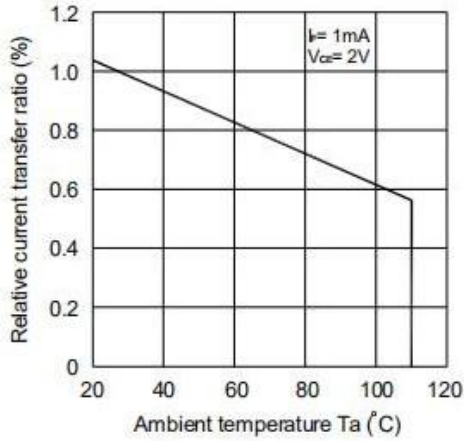


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

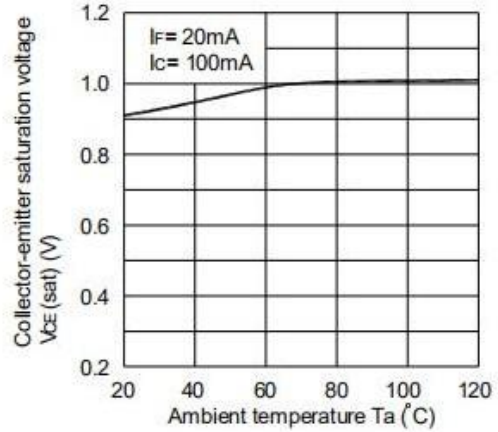


Fig.9 Collector Dark Current vs. Temperature

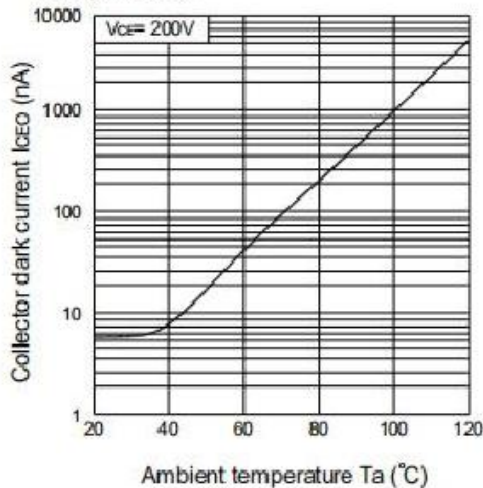


Fig.10 Response Time vs. Load Resistance

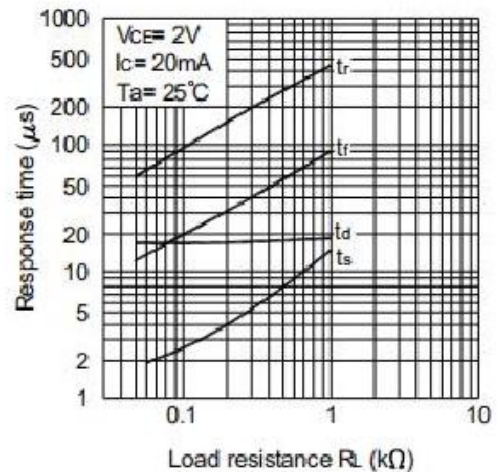
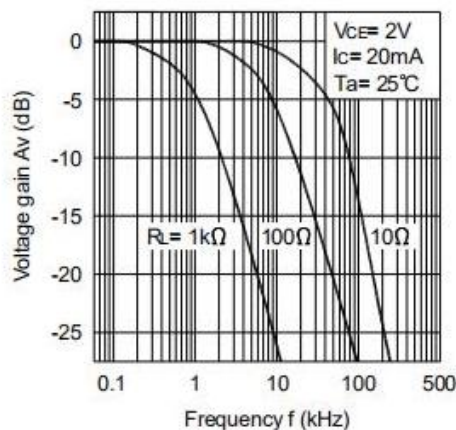
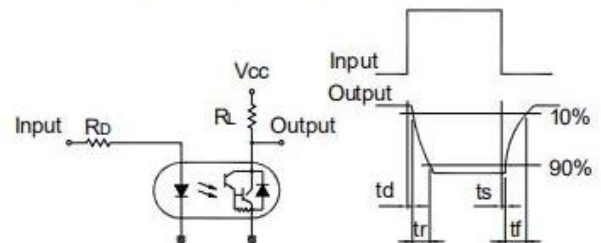


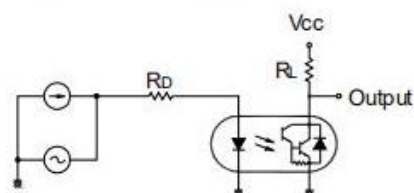
Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response



单击下面可查看定价，库存，交付和生命周期等信息

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